

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Long et al.

Application No.: 10/053,968

Group No.: 3743

Filed: January 22, 2002

Examiner: N/A

For:

RAPID RESPONSE ELECTRIC HEAT EXCHANGER

INFORMATION DISCLOSURE STATEMENT

BOX DD Assistant Commissioner for Patents Washington, D.C. 20231

Sir:

This Information Disclosure Statement is being filed within three months of the filing date of the application or date of entry into the national stage of an international application or before the mailing date of a first Office Action on the merits whichever event occurs last, in keeping with 37 CFR 1.97(b).

Applicant submits herewith patents, publications or other information of which he is aware, if any, which he believes may be material to the examination of this application and in respect of which there may be a duty to disclose in accordance with 37 CFR 1.56.

The filing of this Information Disclosure Statement shall not be construed as a representation that a search has been made (37 CFR 1.56(g)), an admission that the information cited is, or is considered to be, material to patentability or that no other material information exists.

The filing of this Information Disclosure Statement shall not be construed as an admission against interest in any manner. Notice of January 9, 1992, 1135 O.G. 13-25, at 25.

Any such patents, publications or other possibly material information which are known to Applicants are listed on the enclosed is a copy of PTO Form 1449 (modified) listing patents and/or other documents, legible copies of which are enclosed. After reasonable inquiry, no other information material to examination of the above-referenced application is known to Applicants.

Date: MAY 16, 2002

Respectfully submitted,

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Enclosures: PTO-1449 and references cited.

I hereby certify that this correspondence is being deposited in the United States mail, first-class, postage-prepaid in an envelope addressed to Box DD, Assistant Commissioner of Patents, Washington, DC 20231 on May 16, 2002

By: Dawn H. Rogers

typed name of person depositing

Signature